

## APPLICATION DATA SHEET

Electronic Version v14

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<b>Title of Invention</b>	<b>SYSTEM FOR FABRICATING AN INTEGRATED CIRCUIT PACKAGE ON A PRINTED CIRCUIT BOARD</b>		
<b>Application Type:</b> regular, utility <b>Attorney Docket Number:</b> 27-012			
<b>Correspondence address:</b>			
<b>Customer Number:</b>		<b>22898</b>	<b>*22898*</b>
<b>Continuing Data:</b>			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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